EVM User's Guide: UCC2183XXQEVM-123

UCC2183xx Evaluation Module

Description

The UCC2183XXQEVM-123 is a compact, half-bridge gate driver board consisting of two single-channel isolated gate drivers. The EVM provides isolated bias supply, drive current, protection and monitoring needed for driving several different models of Wolfspeed® silicon-carbide (SiC) MOSFET modules and other IGBT or SiC MOSFET modules with a similar pinout. The on-board isolated bias can provide adjustable isolated voltage with passive component change.

Get Started

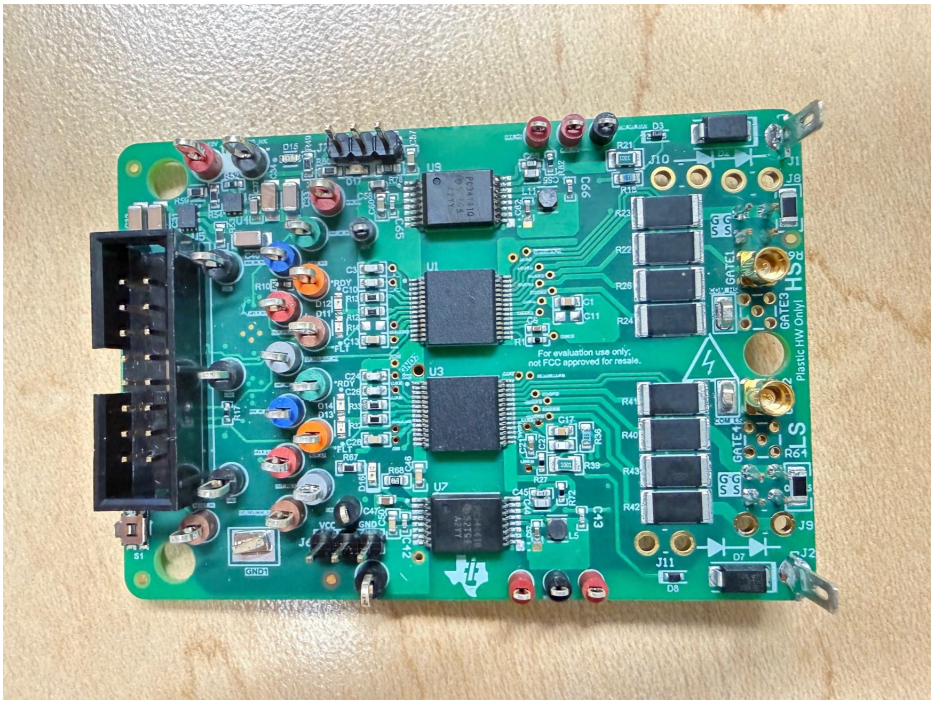
1. Order the *UCC2183XXQEVM-123 EVM*.
2. Download the latest libraries.
3. Download the comprehensive reference design files.
4. See UCC218300-Q1 15A Adjustable Drive Strength Reinforced Isolated Single Channel Gate Driver for SiC/IGBT with Advanced Protection.

Features

- Fully compatible with UCC2183xx family of isolated gate drivers
- Directly compatible with the FM3 and XM3 modules from Wolfspeed
- UCC34141 isolated bias supplies up to 1.5W to each driver
  - Only a +12V input voltage needed to generate the primary-side and secondary-side bias voltage
- Status LEDs indicate power-good and fault feedback from each driver
- Test points for all critical nodes to expedite debugging

Applications

- Traction inverter for EVs
- On-board charger and charging pile
- DC-DC converter for HEV/EVs



UCC2183XXQEVM-123

1 Evaluation Module Overview

1.1 Introduction

The UCC2183XXQEVM-123 is a compact, half-bridge gate driver board consisting of two single-channel isolated gate drivers. The evaluation module provides isolated bias supply, drive current, protection and monitoring needed for driving several different models of Wolfspeed silicon-carbide (SiC) MOSFET modules and other IGBT or SiC MOSFET modules with a similar pinout. The onboard isolated bias can provide adjustable isolated voltage with passive component change.

The compact form factor of the board, combined with the $5kV_{RMS}$ reinforced isolation of the UCC2183XX, makes this module a good candidate for doing high-voltage tests, such as double-pulse tests and short-circuit tests, with the Wolfspeed SiC modules.

This user's guide describes the characteristics, operation and use of the UCC2183XXQEVM-123 Evaluation Module (EVM).

A complete schematic diagram, printed circuit board layouts, and bill of materials are included in this document.

1.2 Kit Contents

DESIGNATOR	QUANTITY	DESCRIPTION	PART NUMBER
HVP123A	1	UCC2183XXQEVM-123 Printed Circuit Board	HVP123A

1.3 Specification

Wide bandgap SiC FET based power modules are introduced in power electronics instead of Si IGBT because of excellent conduction and switching performance. Compact driver board UCC2183XXQEVM-123 supports SiC modules by reducing parasitics, minimizing switching loss, EMI and providing full required protection and diagnostics features.

Table 1-1. Electrical Specifications: UCC2183XXQEVM-123

PARAMETER		TEST CONDITIONS	MIN	NOM	MAX	UNIT
SUPPLY VOLTAGES AND CURRENTS						
Vcc	VCC supply voltage		4.5	5.0	5.5	V
Vdd2u, Vdd2l	VDD supply voltages	From transformer and LDO		15		V
Vee2u, Vee2l	VEE supply voltages	From transformer and shunt regulator		-4		V
DRIVE CURRENT						
Ioh1	Peak source current	CLOAD = 220nF		5		A
Ioh2	Peak source current	CLOAD = 220nF		10		A
Iol	Peak sink current	CLOAD = 220nF		5		A
Iol2	Peak sink current	CLOAD = 220nF		10		A
INPUT/OUTPUT SIGNALS						
Vinr, Vrstr	IN+, IN-, RST/EN rising threshold				0.7 × VCC	V
Vinf, Vrstf	IN+, IN-, RST/EN falling threshold		0.3 × VCC			V
Vinh, Vrsth	INL+, INU+, RST hysteresis			0.19 × VCC		V
TIMING PARAMETERS						
Trise	Driver output rise time	CLOAD = 1.0nF		13		ns
Tfall	Driver output fall time	CLOAD = 1..0nF		12		ns
Tprop	Propagation delay	CLOAD = 1.0F		90		ns
SHORT CIRCUIT PROTECTION - DESAT						

Table 1-1. Electrical Specifications: UCC2183XXQEVM-123 (continued)

PARAMETER		TEST CONDITIONS	MIN	NOM	MAX	UNIT
Ichg	Blanking capacitor charging current			540		uA
Tdesatleb	Leading edge blank time			200		ns
Tdesatfil	DESAT deglitch filter			125		ns
Issd	Peak sink soft shutdown peak current	CL = 0.22µF, fS = 1kHz		2.5		A
Vclmpi	Miller Clamp threshold	Reference to VEE	1.5	2.1	2.5	V
Iclmpi	Miller Clamp current	VCLMPI = 0V, VEE = –2.5V		4		A
ISOLATION						
Viso	Withstand isolation voltage for gate driver	Reinforced, 60s		5000		Vrms
Cio	Barrier capacitance for gate driver			1.2		pF
Ta	Operating Ambient Temperature for gate driver		-40	25	125	°C

1.3.1 Supported Wolfspeed Modules and Evaluation Platforms

Below is a list of Wolfspeed evaluation platforms and SiC modules the half-bridge gate driver board supports.

Table 1-2. Wolfspeed Evaluation Platforms and SiC Modules Supported

Wolfspeed Design	Wolfspeed Parts Supported	Description
SpeedVal™ Kit	650-1200V Discrete MOSFETs, FM Half-Bridge Modules	Dynamic Characterization and Power Testing Platform
KIT-CRD-CIL12N-XM3	1200V XM Power Modules	Dynamic Characterization Platform
KIT-CRD-CIL12N-GMA	1200V GM Half-Bridge Modules	Dynamic Characterization Platform
KIT-CRD-CIL12N-FMA	1200V Half-Bridge FM Power Modules	Dynamic Characterization Platform
KIT-CRD-CIL12N-FMB	1200V FM Full-Bridge Modules	Dynamic Characterization Platform
KIT-CRD-CIL12N-FMC	1200V 6-Pack FM Power Modules	Dynamic Characterization Platform

Other SiC MOSFET modules and IGBT modules with similar pinouts are directly supported as well.

1.3.2 Supported Gate Drivers

Table 1-3. Supported Gate Drivers

GATE DRIVER	SUPPORT	EVM PART NUMBER	MILLER CLAMP	PEAK CURRENT RATING	SC PROTECTION	MODIFICATIONS NEEDED
UCC218302-Q1	Available as EVM	UCC218302EVM-123	Internal	15A	DESAT (9V)	None

1.4 Device Information

1.4.1 Primary-Side Power

The primary-side power supply block fulfills the following functions:

- Provides +12V input to the board through the connector or the test-point hooks.
- Converts the +12V input voltage to +5V VCC for the gate drivers. This functionality is realized by a TPS7A25 LDO.
- The +12V power supply and the PWM signals must connect to the same board, either the differential board or the EVM. Failure to do so can result in EVM component damage.

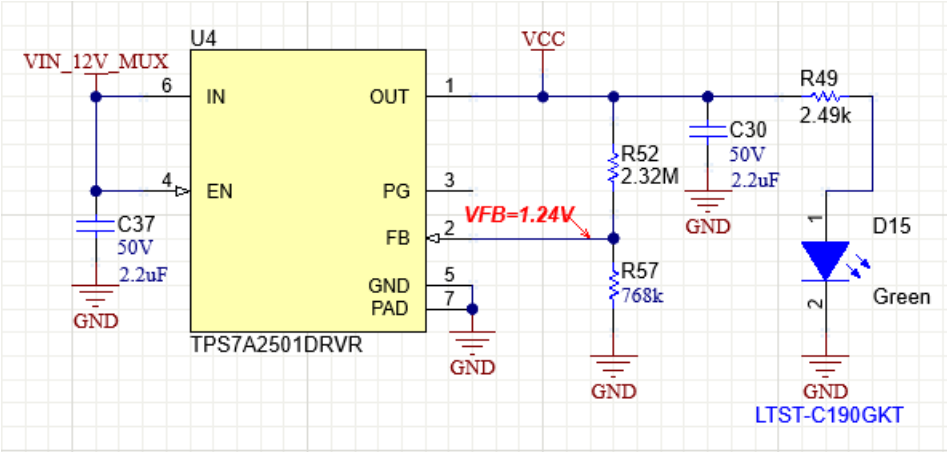


Figure 1-1. Primary-Side Power

1.4.2 Primary-Side I/O and Diagnostics

The primary-side I/O and diagnostic block fulfills the following functions:

- Provides signal input, including high-side and low-side PWM and RESET, as well as +12V voltage input to the half-bridge board.
  - If the power and signal inputs are given through the differential board connector, the status output pin of a power MUX, TPS2121, is used to turn on the SN65C1167 dual differential driver and receiver. The dual differential driver and receiver then converts the differential gate driver inputs to single-ended gate driver inputs, and converts single-ended gate driver outputs to differential outputs that is transmitted to the differential board.
  - If the power and signal inputs are given through the test point hooks on this EVM, the power MUX turns off the SN65C1167 dual differential driver and receiver. This protects the dual differential driver and receiver from damage.
- Filters out the high-frequency noise in the high-side and low-side differential signals through RLC filters.
- Combines high-side and low-side RDY and nFLT signal into one FLT_OUT signal through an SN74LV21 AND gate.
- Combines the nRST signal coming from the differential board and the on-board reset button into one RESET signal through an SN74LV21 AND gate.

  Connect the +12V power supply and PWM signals to the same board, either the differential board or the EVM. Failure to do so can result in EVM component damage.

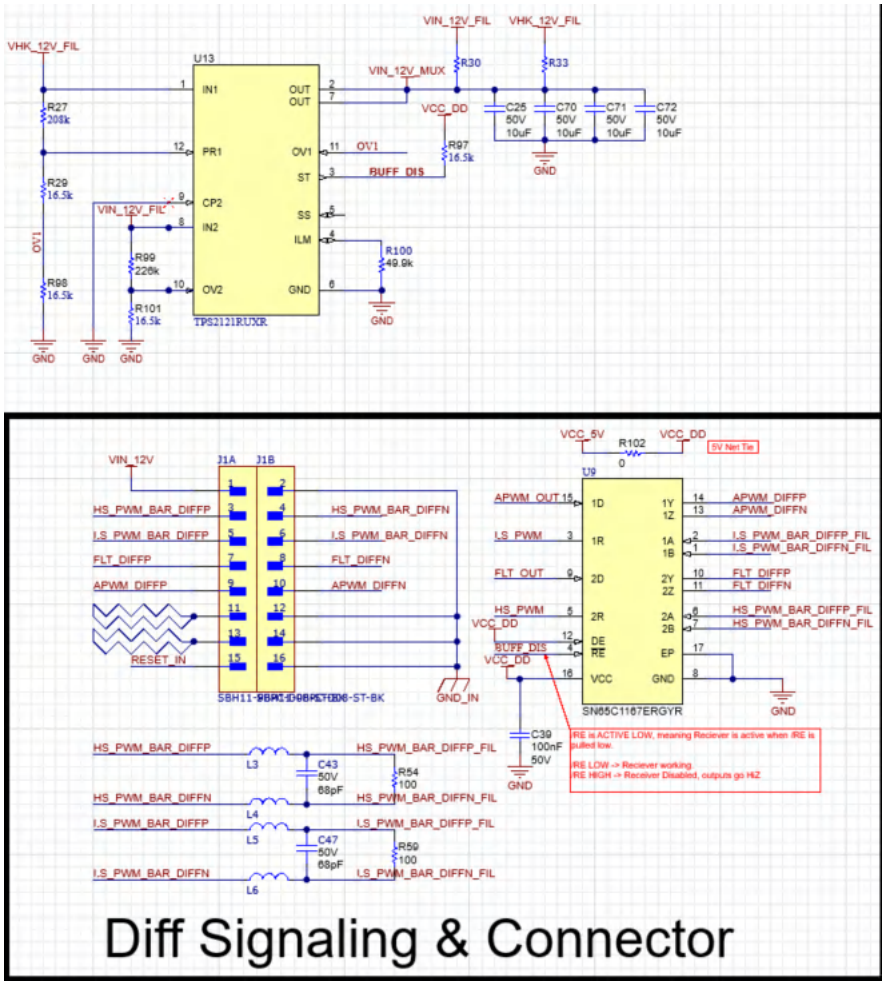


Figure 1-2. Diff Signaling and Connector

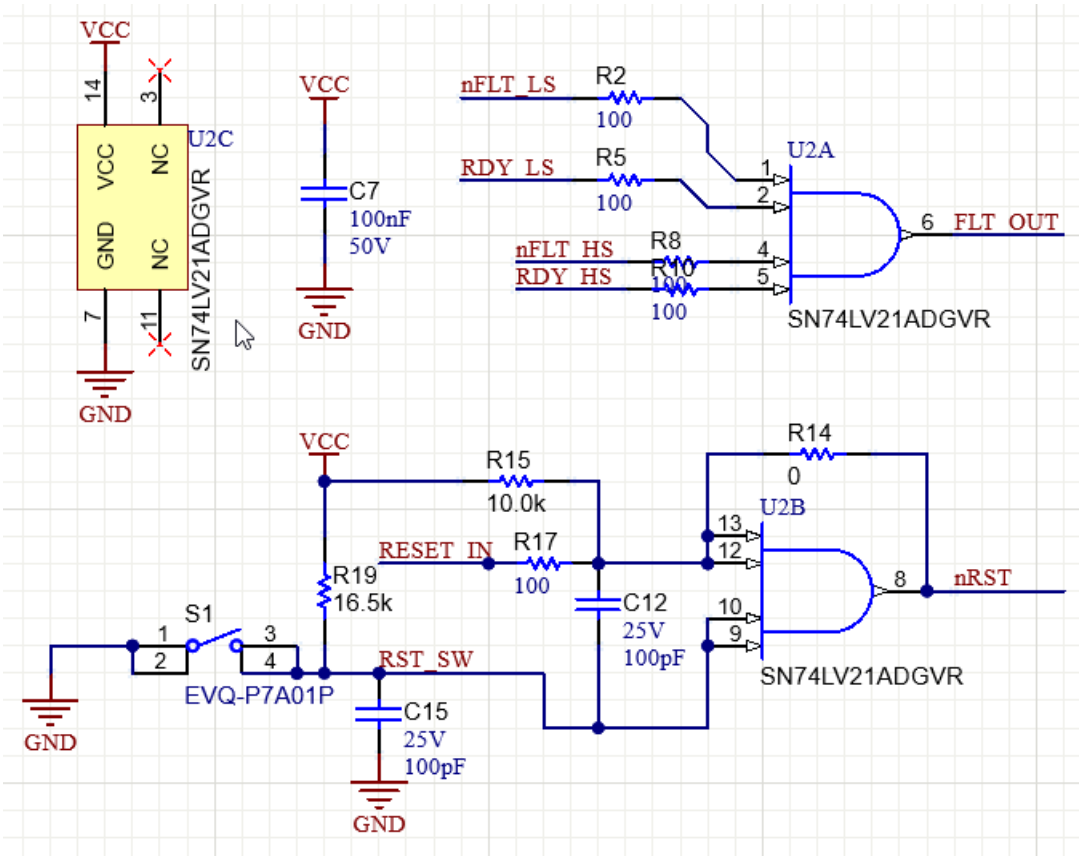


Figure 1-3. Primary-Side I/O

1.4.3 Secondary-Side Bias Supply

The secondary-side power supply block converts the +12V input voltage to +15V/-8V bipolar bias voltage supply for the secondary side of the gate drivers. Each gate driver has its own bias supply. This is achieved by using one UCC34141 Isolated Bias. Adjust the bias supply voltage by changing the FBVDD, FBVEE resistor, and capacitor values. Details will be added in the next revision of the user guide.

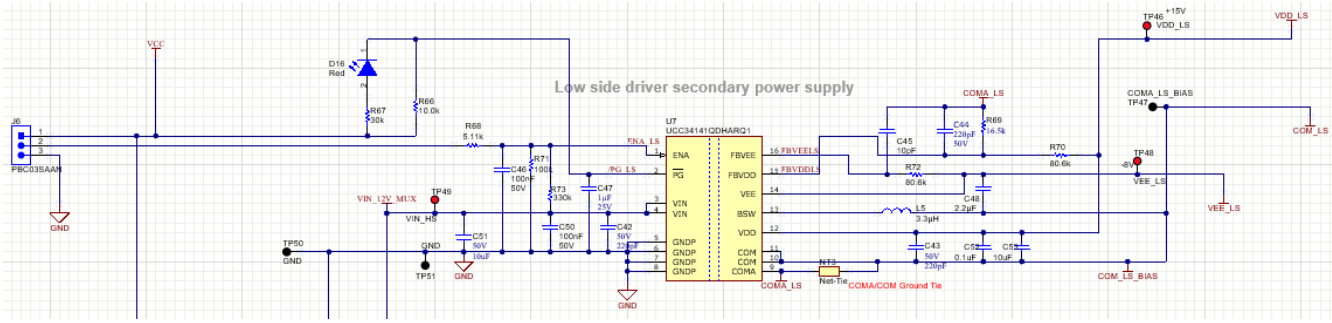


Figure 1-4. Secondary-Side Bias Supply

1.4.4 Output Stage Gate Loop

The gate driver output block consists of the turn-on gate resistor, the turn-off gate resistor, and the connectors to the SiC MOSFET/IGBT module.

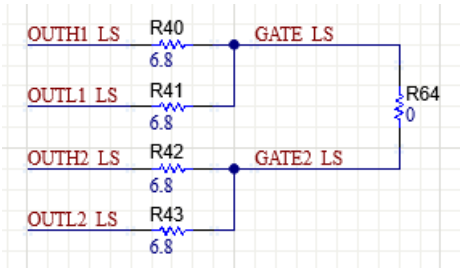


Figure 1-5. Output Stage Gate Loop

1.4.5 Short-Circuit Detection System

The short-circuit detection system on the board provides protection in case of a short-circuit event. When a short circuit is detected, the gate driver pulls the OUTL low with a fixed current soft turn-off, and the FLT flag raises on the primary side. If the short-circuit detection system is not used or if an IGBT/MOSFET is not connected to the board, short J1 and J2 to the respective HS and LS COM to prevent false short-circuit triggering.

1.4.5.1 Short-Circuit Detection - DESAT

Choosing Appropriate Protection Approach for IGBT and SiC Power Modules includes the detailed DESAT protection approach and the design guide. Please refer this application note for the design choices for the components and formula details.

Calculate the Vds voltage detection threshold with the equation:

$$V_{DET} = V_{DESAT} - V_Z - n \times V_F - I_{chg} \times R_{lim} \quad (1)$$

With the 9V internal DESAT detection threshold, the two STTH122A diodes with forward voltage of 0.6V each, the 1k-Ω limiting resistor, the Zener diode with 2.7V Zener voltage, and the 540µA internal charging current, the Vds DESAT detection threshold is calculated as 4.56V. If using another Vds voltage detection threshold, use different Rlim diodes to create the needed detection voltage.

Increase the DESAT charging current by installing R18. Increasing the DESAT charging current can decrease the blanking time of the capacitor and provide better protection for SiC MOSFETs.

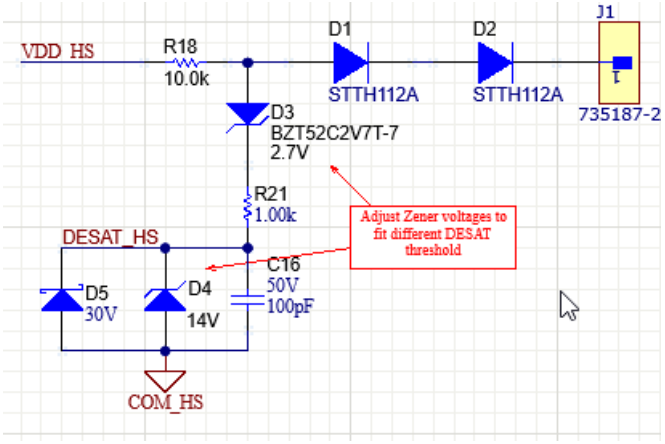


Figure 1-6. DESAT Circuit

1.4.6 PCB Pinout

Table 1-4. PCB Pinout [HS]

PINOUT	LOCATION (TOP/BOTTOM)	FUNCTION
J1	Top	HS DESAT drain connection
J2	Top	LS DESAT drain connection
VHK_12	Top, white	Board 12V Input for both HS and LS

Table 1-4. PCB Pinout [HS] (continued)

PINOUT	LOCATION (TOP/BOTTOM)	FUNCTION
VIN	Top	Bias input voltage for both HS and LS (12V)
J3	Bottom	HS gate/source connection
J4	Bottom	LS gate/source connection
J5	Top	16-pin connector to connect differential signals to the EVM
J6	Top	LS_Bias Enable
J7	Top	HS_Bias Enable
J8	Top	GATE2_HS connector to GATE_HS
J9	Top	GATE2_LS connector to GATE_LS
J10	Top	COM
J11	Top	COM
GATE1	Top	MMCX connector, HS gate 1
GATE2	Top	MMCX connector, LS gate 1
GATE3	Top	MMCX connector, HS gate 2
GATE4	Top	MMCX connector, LS gate 2
INP_IN[HS]	Top, green	HS PWM input
INP_IN[LS]	Top, green	LS PWM input
INN_IN[HS]	Top, blue	Non - inverting gate driver control input
INN_IN[LS]	Top, blue	Inverting gate driver control input
RDY[HS]	Top, orange	HS RDY
RDY[LS]	Top, orange	LS RDY
FLT[LS]	Top, red	LS nFLT
FLT[HS]	Top, red	HS nFLT
OUT_FB[HS]	Top, gray	HS output feedback
OUT_FB[LS]	Top, gray	LS output feedback
VDD[HS]	Top, red	HS VDD Voltage
VEE[HS]	Top, red	HS VEE Voltage
COM_HS, COM_HS_BIAS	Top, black	HS Side COM
VDD[LS]	Top, red	LS VDD Voltage
VEE[LS]	Top, red	LS VEE Voltage
COM_LS, COM_LS_BIAS	Top, black	LS Side COM
RESET_IN	Top, white	HS and LS combined nRST
S1	Top	Switch to reset HS/LS gate driver/bias
GND, GND_HK	Top	Primary side GND

1.5 General TI High Voltage Evaluation User Safety Guidelines

Always follow TI's set-up and application instructions, including use of all interface components within their recommended electrical rated voltage and power limits. Always use electrical safety precautions to help ensure your personal safety and the safety of those working around you. Contact TI's Product Information Center http://support/ti./com for further information.

Save all warnings and instructions for future reference.

Failure to follow warnings and instructions may result in personal injury, property damage, or death due to electrical shock and/or burn hazards.

The term TI HV EVM refers to an electronic device typically provided as an open framed, unenclosed printed circuit board assembly. It is intended strictly for use in development laboratory environments, solely for qualified professional users having training, expertise, and knowledge of electrical safety risks in development and application of high-voltage electrical circuits. Any other use and/or application are strictly prohibited by Texas Instruments. If you are not suitably qualified, you must immediately stop from further use of the HV EVM.

- **Work Area Safety:**
  - Maintain a clean and orderly work area .
  - Qualified observer(s) must be present anytime circuits are energized.
  - Effective barriers and signage must be present in the area where the TI HV EVM and its interface electronics are energized, indicating operation of accessible high voltages may be present, for the purpose of protecting inadvertent access.
  - All interface circuits, power supplies, evaluation modules, instruments, meters, scopes and other related apparatus used in a development environment exceeding 50 V_{RMS}/75VDC must be electrically located within a protected Emergency Power Off (EPO) protected power strip.
  - Use a stable and non-conductive work surface.
  - Use adequately insulated clamps and wires to attach measurement probes and instruments. No freehand testing whenever possible.
- **Electrical Safety:**

  As a precautionary measure, it is always a good engineering practice to assume that the entire EVM may have fully accessible and active high voltages.

  - De-energize the TI HV EVM and all its inputs, outputs, and electrical loads before performing any electrical or other diagnostic measurements. Confirm that TI HV EVM power has been safely de-energized.
  - With the EVM confirmed de-energized, proceed with required electrical circuit configurations, wiring, measurement equipment hook-ups and other application needs, while still assuming the EVM circuit and measuring instruments are electrically live.
  - When EVM readiness is complete, energize the EVM as intended.

  WARNING

  WARNING: While the EVM is energized, never touch the EVM or its electrical circuits as they could be at high voltages capable of causing electrical shock hazard.
- **Personal Safety:**
  - Wear personal protective equipment, for example, latex gloves and/or safety glasses with side shields or protect EVM in an adequate lucent plastic box with interlocks from accidental touch.
- **Limitation for Safe Use:**
  - EVMs are not to be used as all or part of a production unit.

Safety and Precautions

The EVM is designed for professionals who have received the appropriate technical training, and is designed to operate from an AC power supply or a high-voltage DC supply. Please read this user guide and the safety-related documents that come with the EVM package before operating this EVM.

CAUTION

⚠

Do not leave the EVM powered when unattended.

WARNING

⚠

High Voltage! Electric shock is possible when connecting board to live wire. Board must be handled with care by a professional.

For safety, use of isolated test equipment with overvoltage and overcurrent protection is highly recommended.

2 Using the EVM

2.1 Equipment List and Board Setup

- Power supplies
  - Need to provide at least 12V and 1A to power up the EVM
- Function generator and accessories
  - One 2-channel function generator
  - Two standard 50Ω BNC coaxial cables
- Oscilloscope and accessories
  - Oscilloscope 500MHz or higher with at least four channels
  - Four passive voltage probes with at least 500MHz bandwidth
- Digital multimeters
  - Two digital multimeters
- Other
  - Connection wires of various length

2.2 Test Setups and Procedures

2.2.1 Power-On and Bias Supply Check

Note

This is a low voltage only test; do not try to manually probe the test points when a high bus voltage is applied to this EVM.

1. Board setup
   a. Place jumpers at **J7** and **J6**. Connect **VCC** to **VCC** and **ENA_HS** to **ENA_LS**.
   b. Tie **J1 to COM_HS** and **J2 to COM_LS**.
   c. Tie **INN_IN[HS]** and **INN_IN[LS]** to a GND test point.
   d. Power supply set at 12V, 1A. Connect power supply to **VHK_12V** (power) and **GND_HK** (GND)
2. Probe the VCC-GND voltage between the VCC TP and any GND TP with a multimeter. This value must be 5V.
3. Probe the high side VDD-COM voltage by using the VDD TP and the COM TP from HS. Probe the low side VDD-COM voltage using the VDD TP and the COM TP from LS. These values must be approximately 15V.
4. Probe the high side VEE-COM voltage using the VEE TP and the COM TP. Probe the low side VEE-COM voltage using the VEE TP and the COM TP. These values must be approximately -8V.
5. Make sure the indicator LEDs are OFF

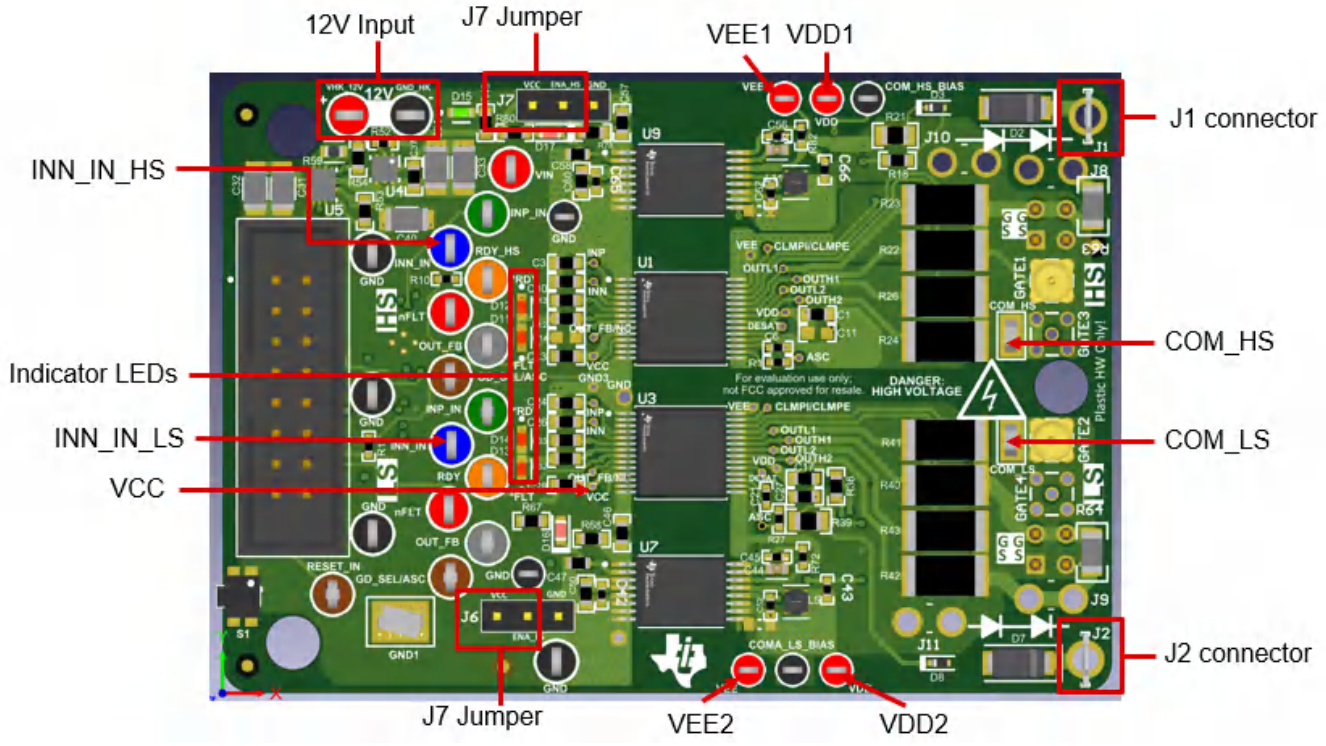


Figure 2-1. Jumper Settings and Test Points

2.2.2 Output Switching

To perform this test, perform the tests in Section 2.2.1 and correctly power up the gate drivers.

1. Generate two 10kHz from 0V to 5V complementary PWM waves on two function generator channels. Optionally, add deadtime between the two PWM waves.
2. Connect these channel probes to the test points on the EVM; connect the high-side PWM channel probe to **INP_IN[HS]** and the low-side PWM channel probe to **INP_IN[LS}**.
3. Measure the high-side gate voltage with the MMCX connector **GATE1**, and measure the low-side gate voltage with the MMCX connector **GATE2.**
4. **GATE1** waveform must match high-side PWM input signal with a small delay (approximately 100ns).
5. **GATE2** waveform must match low-side PWM input signal with a small delay (approximately 100ns).

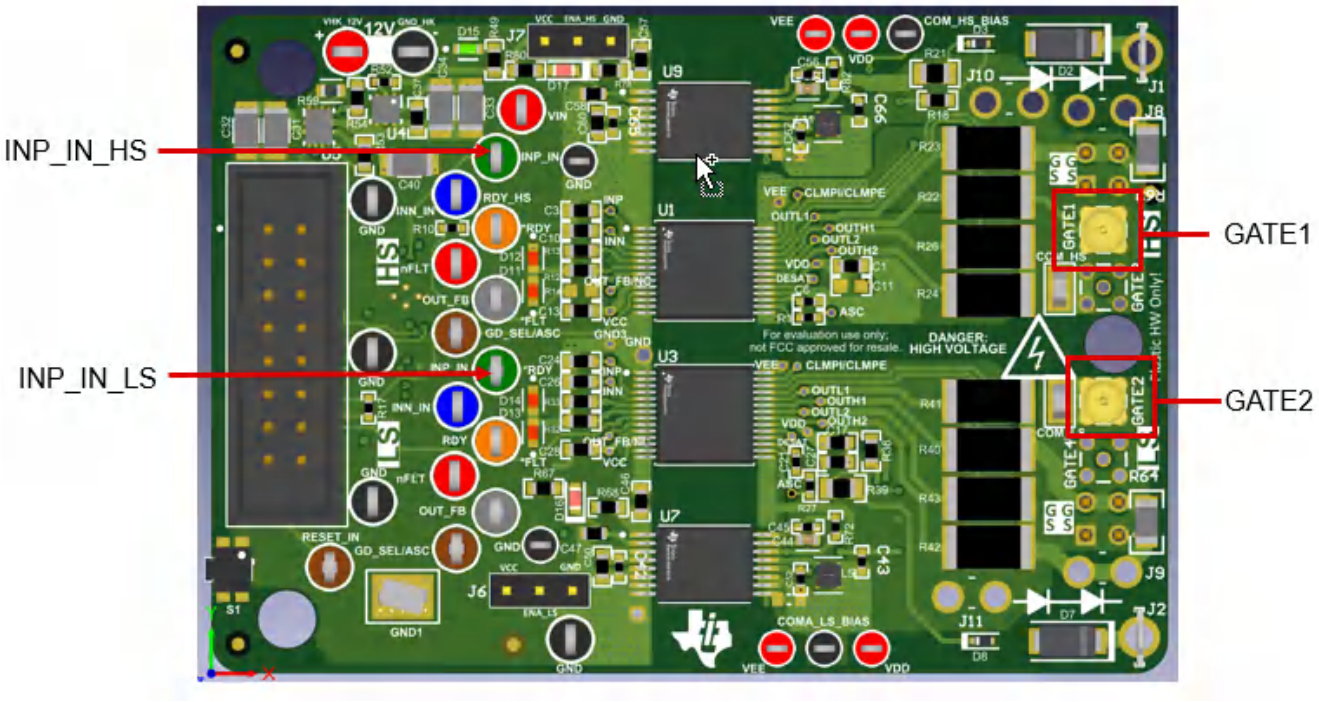


Figure 2-2. Test Point Locations for Output Switching Check

3 Hardware Design Files

3.1 Schematics

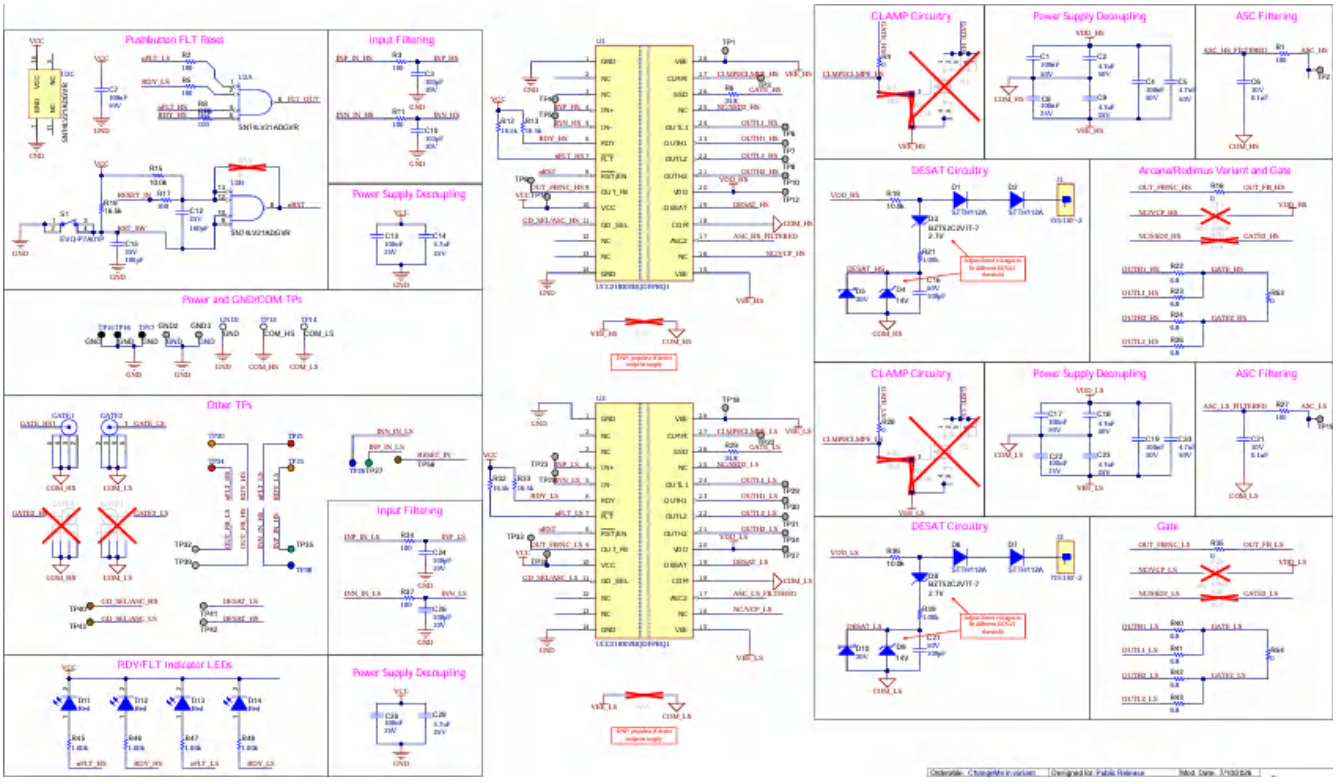


Figure 3-1. UCC2183XXQEVM-123 EVM Schematic

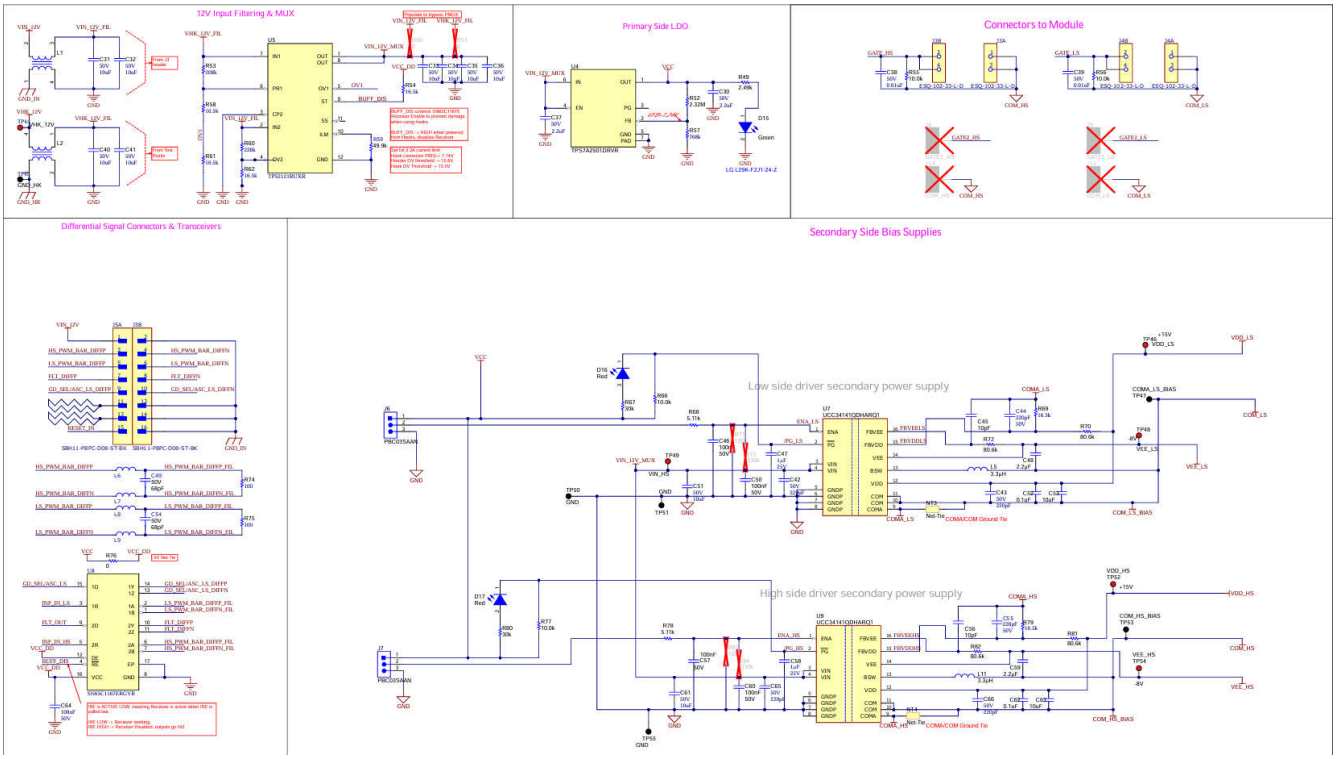


Figure 3-2. UCC2183XXQEVM-123 EVM Schematic

3.2 PCB Layouts

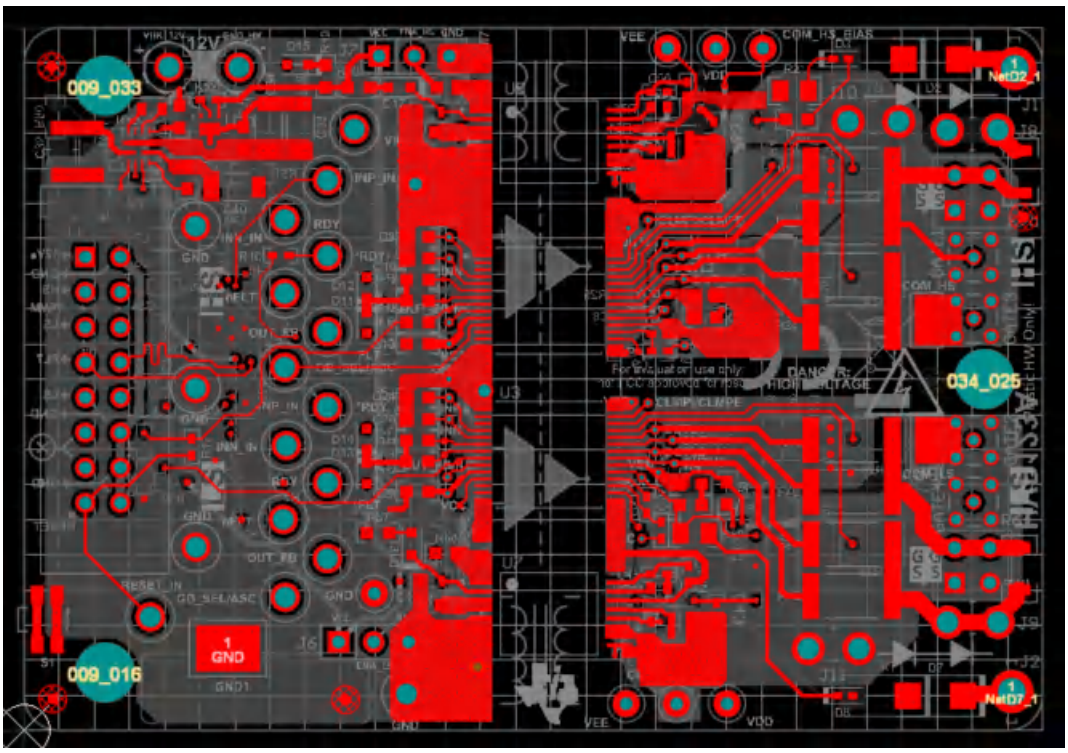


Figure 3-3. Top Layer

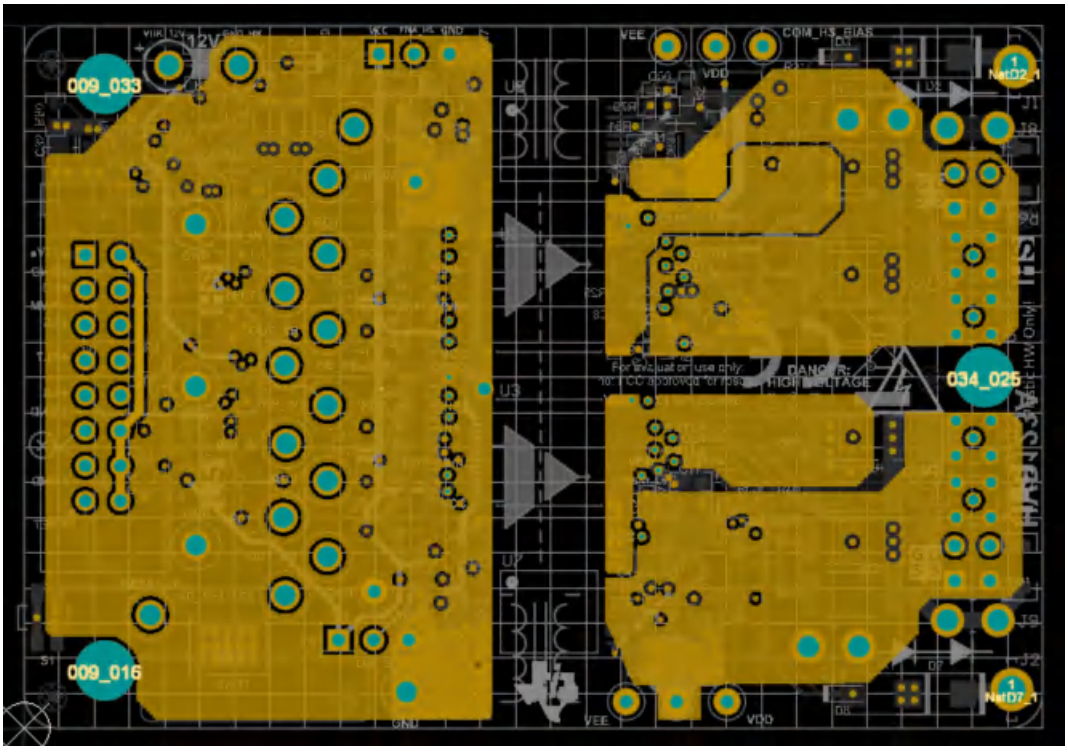


Figure 3-4. Signal Layer 1

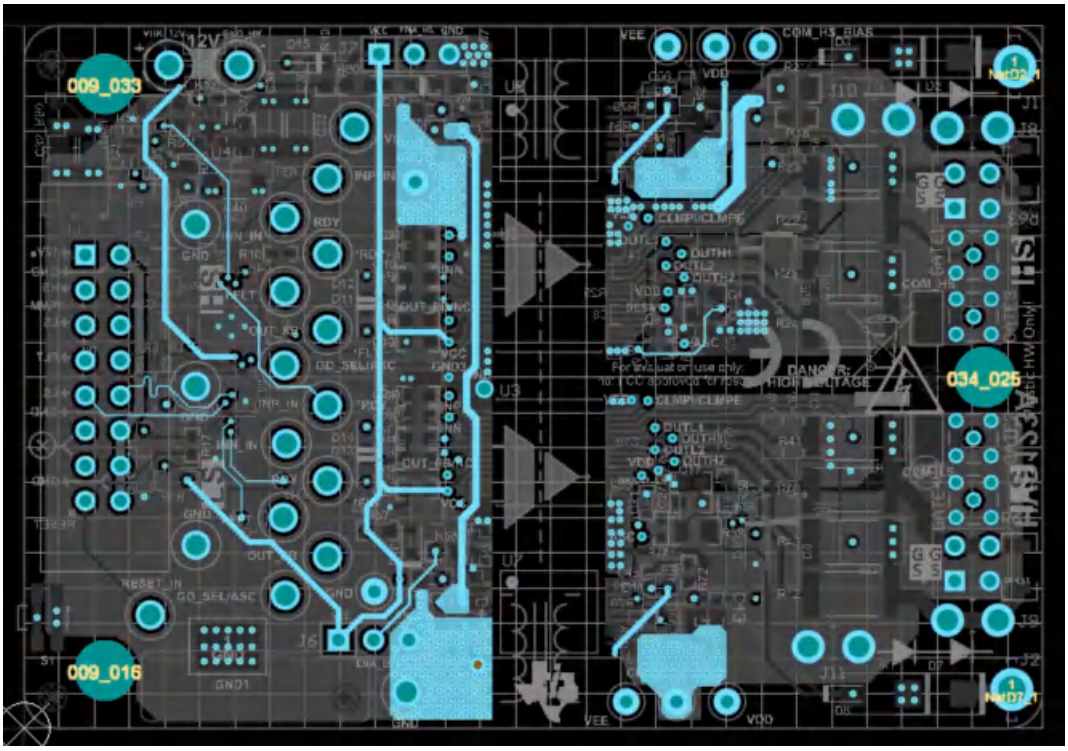


Figure 3-5. Signal Layer 2

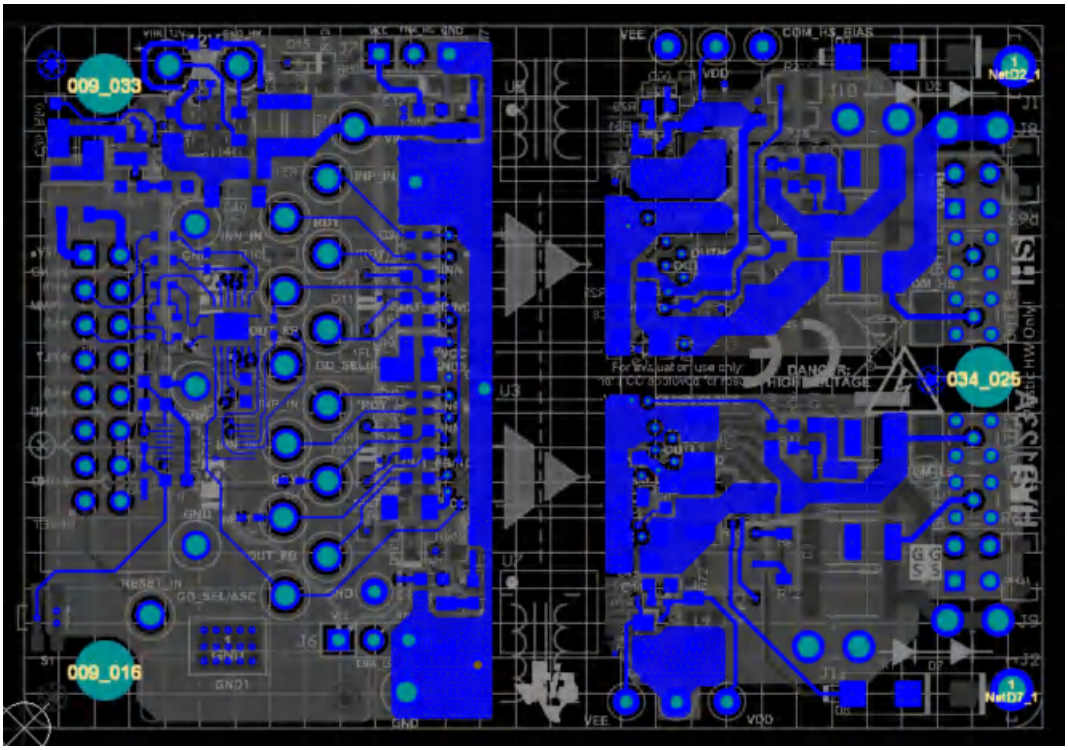


Figure 3-6. Bottom Layer

3.3 Bill of Materials (BOM)

Table 3-1. UCC2183XXQEVM-123

Designator	Quantity	Description	Part Number
!PCB	1	Printed Circuit Board	HVP123A
C1, C4, C17, C19	4	CAP, CERM, 0.1uF, 50V, ± 10%, X7R, 0603	8.85012E+11
C2, C5, C18, C20	4	CAP, CERM, 4.7uF, 50V, ± 10%, X7R, 1210	C3225X7R1H475K250AB
C3, C10, C24, C26	4	CAP, CERM, 100pF, 10V, ± 10%, X7R, 0603	0603ZC101KAT2A
C6, C21	2	CAP, CERM, 0.1uF, 10V,± 10%, X5R, 0402	LMK105BJ104KV-F
C7, C46, C50, C57, C60, C64	6	CAP, CERM, 0.1uF, 50V, ± 10%, X7R, 0603	C0603C104K5RACTU
C8, C13, C22, C28	4	CAP, CERM, 0.1uF, 25V, ± 10%, X7R, 0603	C0603X104K3RACTU
C9, C14, C23, C29	4	CAP, CERM, 4.7uF, 25V, ± 20%, X5R, 1206	12063D475MAT2A
C12, C15	2	CAP, CERM, 100pF, 25V, ± 5%, C0G/NP0, 0402	C0402C101J3GACTU
C16, C27	2	CAP, CERM, 100pF, 50V, ± 5%, C0G/NP0, AEC-Q200 Grade 0, 0603	CGA3E2NP01H101J080AA
C30, C37	2	CAP, CERM, 2.2uF, 50V, ± 10%, X5R, 0603	GRM188R61H225KE11D
C31, C32, C33, C34, C35, C36, C40, C41	8	CAP, CERM, 10uF, 50V, ± 10%, X5R, 1206	C3216X5R1H106K160AB
C38, C39	2	CAP, CERM, 0.01uF, 50V, ± 10%, X7R, 0402	GRM155R71H103KA88D
C42, C43, C65, C66	4	CAP, CERM, 220pF, 50V,± 5%, C0G/NP0, AEC-Q200 Grade 1, 0402	CGA2B2C0G1H221J050BA
C44, C55	2	220pF ±5% 50V Ceramic Capacitor C0G, NP0 0603 (1608 Metric)	C0603C221J5GAC7867
C45, C56	2	CAP, CERM, 10pF, 50V, ± 5%, C0G/NP0, AEC-Q200 Grade 1, 0402	CGA2B2C0G1H100D050BA
C47, C58	2	CAP, CERM, 1 µF, 25V,± 10%, X7R, AEC-Q200 Grade 1, 0603	CGA3E1X7R1E105K080AC
C48, C59	2	CAP, CERM, 2.2uF, 16V, ± 10%, X7R, 0805	C2012X7R1C225K125AB
C49, C54	2	68pF ±5% 50V Ceramic Capacitor C0G, NP0 0402 (1005 Metric)	GCM1555C1H680JA16D
C51, C61	2	CAP, CERM, 10uF, 50V, ± 10%, X7R, 1206	CL31B106KBHNNNE

Table 3-1. UCC2183XXQEVM-123 (continued)

Designator	Quantity	Description	Part Number
C52, C62	2	CAP, CERM, 0.1uF, 50V, ± 10%, X7R, AEC-Q200 Grade 1, 0402	GCM155R71H104KE02D
C53, C63	2	CAP, CERM, 10uF, 35V, ± 10%, X7R, AEC-Q200 Grade 1, 1206_190	CGA5L1X7R1V106K160AC
D1, D2, D6, D7	4	Diode, Ultrafast, 1200V, 1A, SMA	STTH112A
D3, D8	2	Diode, Zener, 2.7V, 300mW, SOD-523	BZT52C2V7T-7
D4, D9	2	Diode, Zener, 14V, 500mW, SOD-123	DDZ14B-7
D5, D10	2	Diode, Schottky, 30V, 0.2A, SOD-323	BAT54WS-7F
D11, D12, D13, D14	4	LED, Red, SMD	LTST-C190KRKT
D15	1	LED, Green, SMD	LTST-C190GKT
D16, D17	2	LED, Red, SMD	150060RS75000
FID4, FID5, FID6	3	Fiducial mark. There is nothing to buy or mount.	N/A
GATE1, GATE2	2	Connector, MMCX 50Ω, TH	MMCX-J-P-H-ST-TH1
GND1	1	Test Point, Compact, SMT	5016
J1, J2	2	FASTON 110, PCB Terminals, Tab, Tab, PCB Terminal Mating Tab Width 0.11 in [2.8mm], PCB Terminal Mating Tab Thickness 0.02 in [.51mm]	735187-2
J3, J4	2	4 Position Elevated Socket Connector Through Hole	ESQ-102-33L-D
J5	1		SBH11-PBPC-D08-ST-BK
J6, J7	2	Header, 100mil, 3x1, Gold, TH	PBC03SAAN
L1, L2	2	Coupled inductor, 2.8A, 0.055Ω, SMD	ACM4520-421-2P-T000
L5, L11	2	Inductor Power Shielded Wirewound 3.3uH 20% 100KHz Ferrite 0.88A 0.3Ω DCR T/R	NRV2010T3R3MGF
L6, L7, L8, L9	4	1µH Shielded Multilayer Inductor 600mA 150mΩ 0603 (1608 Metric)	MLZ1608A1R0WT000
LBL1	1	Thermal Transfer Printable Labels, 0.650" W × 0.200" H - 10,000 per roll	THT-14-423-10
R1, R3, R11, R27, R34, R37	6	RES, 100, 1%, 0.125W, AEC-Q200 Grade 1, 0402	ATC504L1000FTNCFT
R2, R5, R8, R10, R17, R74, R75	7	RES, 100, 5%, 0.063W, AEC-Q200 Grade 0, 0402	CRCW0402100RJNED
R4, R16, R28, R35, R76	5	RES, 0, 5%, 0.125W, 0603	MCT06030Z0000ZP500
R6, R29	2	RES, 34.8, 1%, 0.5W, 1210	RC1210FR-0734R8L

Table 3-1. UCC2183XXQEVM-123 (continued)

Designator	Quantity	Description	Part Number
R12, R13, R19, R32, R33, R54, R58, R61, R62, R69, R79	11	RES, 16.5k, 1%, 0.1W, AEC-Q200 Grade 0, 0603	ERJ-3EKF1652V
R15, R18, R36, R55, R56	5	RES, 10.0k, 1%, 0.1W, 0603	RC0603FR-0710KL
R21, R39	2	RES, 1.00k, 0.1%, 0.125W, 0805	RT0805BRD071KL
R22, R23, R24, R26, R40, R41, R42, R43	8	RES, 6.8, 5%, 1W, AEC-Q200 Grade 0, 2512	CRCW25126R80JNEG
R45, R46, R47, R48	4	RES, 1.00k, 1%, 0.1W, 0603	ERJ-3EKF1001V
R49	1	RES, 2.49k, 1%, 0.1W, AEC-Q200 Grade 0, 0603	CRCW06032K49FKEA
R52	1	RES, 2.32M, 1%, 0.063W, AEC-Q200 Grade 0, 0402	CRCW04022M32FKED
R53	1	RES, 208k, 0.1%, 0.1W, 0603	RT0603BRD07208KL
R57	1	RES, 768k, 1%, 0.063W, AEC-Q200 Grade 0, 0402	CRCW0402768KFKED
R59	1	49.9kΩs ±1% 0.1W, 1/10W Chip Resistor 0603 (1608 Metric) Automotive AEC-Q200 Thick Film	CRCW060349K9FKEA
R60	1	RES, 226k, 1%, 0.1W, AEC-Q200 Grade 0, 0603	CRCW0603226KFKEA
R63, R64	2	RES, 0, 5%, 0.25W, AEC-Q200 Grade 0, 1206	RCA12060000ZSEA
R66, R77	2	RES, 10.0k, 1%, 0.1W, AEC-Q200 Grade 0, 0603	CRCW060310K0FKEA
R67, R80	2	RES, 30k, 5%, 0.1W, AEC-Q200 Grade 0, 0603	CRCW060330K0JNEA
R68, R78	2	RES, 5.11k, 1%, 0.1W, AEC-Q200 Grade 0, 0603	CRCW06035K11FKEA
R70, R72, R81, R82	4	RES, 80.6k, 1%, 0.063W, AEC-Q200 Grade 0, 0402	CRCW040280K6FKED
S1	1	Switch, Tactile, SPST-NO, 0.05A, 12V, SMD	EVQ-P7A01P
TP13, TP14	2	Test Point, Miniature, SMT	5015
TP15, TP16, TP17, TP45, TP50	5	Test Point, Multipurpose, Black, TH	5011
TP20, TP25	2	Test Point, Multipurpose, Orange, TH	5013
TP21, TP24, TP44, TP49	4	Test Point, Multipurpose, Red, TH	5010
TP26, TP38	2	Test Point, Multipurpose, Blue, TH	5127
TP27, TP35	2	Test Point, Multipurpose, Green, TH	5126
TP32, TP39	2	Test Point, Multipurpose, Grey, TH	5128
TP40, TP43, TP56	3	Test Point, Multipurpose, Brown, TH	5125

Table 3-1. UCC2183XXQEVM-123 (continued)

Designator	Quantity	Description	Part Number
TP46, TP48, TP52, TP54	4	Test Point, Miniature, Red, TH	5000
TP47, TP51, TP53, TP55	4	Test Point, Miniature, Black, TH	5001
U1, U3	2	UCC218302BQDFPRQ1	UCC218302BQDFPRQ1
U2	1	Dual 4-Input Positive-AND Gate, DGV0014A (TVSOP-14)	SN74LV21ADGVR
U4	1	300mA, 18V, Low IQ, Low Dropout Voltage Regulator with Power Good, DRV0006A (WSON-6)	TPS7A2501DRVR
U5	1	2.7V-22V, 4A, 50mΩ Priority Power MUX, RUX0012A (VQFN-HR-12)	TPS2121RUXR
U7, U9	2	Automotive 1.5W, 12V-Vin, 25V-Vout, High Efficiency, High-Density, >5kVRMS, Isolated DC-DC Module	UCC34141QDHARQ1
U8	1	Dual Differential Driver and Receiver with ±15kV IEC ESD Protection, 2 TX / 2 RX, 5V, -40 to 85°C, 16-Pin VQFN(RGY), Green (RoHS and no Sb/Br)	SN65C1167ERGYR
C11, C25	0	CAP, CERM, 0.1uF, 50V, ± 10%, X7R, 0603	8.85012E+11
FID1, FID2, FID3	0	Fiducial mark. There is nothing to buy or mount.	N/A
GATE3, GATE4	0	Connector, MMCX 50Ω, TH	MMCX-J-P-H-ST-TH1
J8, J9, J10, J11	0	Terminal Tab Quick-Fit PCB Female 0.110x.020 Tab Brass/ Tin-Nickel	3534
Q1, Q2	0	N-Channel 40V 8A (Ta), 19A (Tc) 2.3W (Ta), 15W (Tc) Surface Mount DFN2020MD-6	BUK6D23-40EX
R7, R30	0	RES, 10.0, 1%, 0.25W, AEC-Q200 Grade 0, 0603	CRCW060310R0FKEAHP
R9, R31	0	RES, 10.0k, 1%, 0.1W, 0603	RC0603FR-0710KL
R14, R50, R51	0	RES, 0, 5%, 0.125W, 0603	MCT06030Z0000ZP500
R20, R38	0	RES, 34.8, 1%, 0.5W, 1210	RC1210FR-0734R8L
R25, R44	0	0Ω Jumper 0.5W, 1/2W Chip Resistor 0805 (2012 Metric) Automotive AEC-Q200 Metal Foil	HCJ0805ZT0R00
R71, R83	0	RES, 100k, 5%, 0.1W, AEC-Q200 Grade 0, 0402	ERJ-2GEJ104X
R73, R84	0	RES, 330k, 1%, 0.1W, AEC-Q200 Grade 0, 0603	ERJ-3EKF3303V

4 Additional Information

4.1 Trademarks

SpeedVal™ is a trademark of Wolfspeed, Inc.
Wolfspeed® is a registered trademark of Wolfspeed, Inc.
All trademarks are the property of their respective owners.

5 References

- Texas Instruments, *Choosing Appropriate Protection Approach for IGBT and SiC Power Modules* application note
- Texas Instruments, *UCC218300-Q1 15A Adjustable Drive Strength Reinforced Isolated Single Channel Gate Driver for SiC/IGBT with Advanced Protection* datasheet
- Texas Instruments, UCC218XXXEVM-111 product page
- Woldspeed, KIT-CRD-CIL12N-FMB
- Woldspeed, KIT-CRD-CIL12N-XM3
- Woldspeed, SpeedVal Kit Modular Evaluation Platform
- Wolfspeed, KIT-CRD-CIL12N-FMA
- Wolfspeed, KIT-CRD-CIL12N-FMC
- Wolfspeed, KIT-CRD-CIL12N-GMA

STANDARD TERMS FOR EVALUATION MODULES

1. *Delivery:* TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an “EVM” or “EVMs”) to the User (“User”) in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.

   1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM (“Software”) shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software

   1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.

2 *Limited Warranty and Related Remedies/Disclaimers*:

   2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.

   2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.

   2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

WARNING

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI’s recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI’s recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI’s instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGREDATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 *Regulatory Notices:*

3.1 *United States*

3.1.1 *Notice applicable to EVMs not FCC-Approved:*

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 *For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:*

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- *Reorient or relocate the receiving antenna.*
- *Increase the separation between the equipment and receiver.*
- *Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.*
- *Consult the dealer or an experienced radio/TV technician for help.*

3.2 *Canada*

3.2.1 *For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247*

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

3.3 *Japan*

3.3.1 *Notice for EVMs delivered in Japan:* Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。

https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-delivered-in-japan.html

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

【無線電波を送信する製品の開発キットをお使いになる際の注意事項】 開発キットの中には技術基準適合証明を受けていないものがあります。 技術適合証明を受けていないもののご使用に際しては、電波法遵守のため、以下のいずれかの措置を取っていただく必要がありますのでご注意ください。

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2. 実験局の免許を取得後ご使用いただく。
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3.3.3 *Notice for EVMs for Power Line Communication:* Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page

電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-for-power-line-communication.html

3.4 *European Union*

3.4.1 *For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive)*:

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

4 *EVM Use Restrictions and Warnings:*

4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.

4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.

4.3 *Safety-Related Warnings and Restrictions:*

4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.

4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.

4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.

5. *Accuracy of Information:* To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

6. *Disclaimers:*

6.1 EXCEPT AS SET FORTH ABOVE, EVMS AND ANY MATERIALS PROVIDED WITH THE EVM (INCLUDING, BUT NOT LIMITED TO, REFERENCE DESIGNS AND THE DESIGN OF THE EVM ITSELF) ARE PROVIDED "AS IS" AND "WITH ALL FAULTS." TI DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, REGARDING SUCH ITEMS, INCLUDING BUT NOT LIMITED TO ANY EPIDEMIC FAILURE WARRANTY OR IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF ANY THIRD PARTY PATENTS, COPYRIGHTS, TRADE SECRETS OR OTHER INTELLECTUAL PROPERTY RIGHTS.

6.2 EXCEPT FOR THE LIMITED RIGHT TO USE THE EVM SET FORTH HEREIN, NOTHING IN THESE TERMS SHALL BE CONSTRUED AS GRANTING OR CONFERRING ANY RIGHTS BY LICENSE, PATENT, OR ANY OTHER INDUSTRIAL OR INTELLECTUAL PROPERTY RIGHT OF TI, ITS SUPPLIERS/LICENSORS OR ANY OTHER THIRD PARTY, TO USE THE EVM IN ANY FINISHED END-USER OR READY-TO-USE FINAL PRODUCT, OR FOR ANY INVENTION, DISCOVERY OR IMPROVEMENT, REGARDLESS OF WHEN MADE, CONCEIVED OR ACQUIRED.

7. *USER'S INDEMNITY OBLIGATIONS AND REPRESENTATIONS.* USER WILL DEFEND, INDEMNIFY AND HOLD TI, ITS LICENSORS AND THEIR REPRESENTATIVES HARMLESS FROM AND AGAINST ANY AND ALL CLAIMS, DAMAGES, LOSSES, EXPENSES, COSTS AND LIABILITIES (COLLECTIVELY, "CLAIMS") ARISING OUT OF OR IN CONNECTION WITH ANY HANDLING OR USE OF THE EVM THAT IS NOT IN ACCORDANCE WITH THESE TERMS. THIS OBLIGATION SHALL APPLY WHETHER CLAIMS ARISE UNDER STATUTE, REGULATION, OR THE LAW OF TORT, CONTRACT OR ANY OTHER LEGAL THEORY, AND EVEN IF THE EVM FAILS TO PERFORM AS DESCRIBED OR EXPECTED.

8. *Limitations on Damages and Liability:*

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